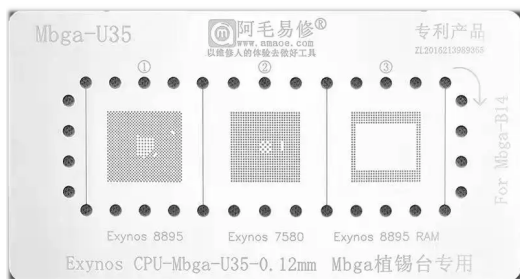


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AMAOE BGA Mbga-U35 stencil reballing BGA CPU Exynos 8895 Exynos7580 Exynos8895RAM 0,12mm for MBGA-B14

Product ID: 23018

Price: **7.00 EUR**

Product weight: **0.20 kg**

Description:

AMAOE BGA Mbga-U35 stencil reballing BGA CPU Exynos 8895 Exynos7580 Exynos8895RAM 0,12mm for MBGA-B14 - the sieves are a product made of steel resistant to high temperatures and deformations. Precise laser-cut templates facilitate positioning during work.

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